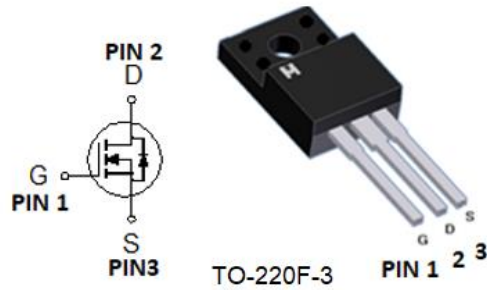


Single N-Channel Logic Level Enhancement Mode Field Effect Transistor

Product Summary:

|                     |              |
|---------------------|--------------|
| $BV_{DSS}$          | 100V         |
| $R_{DS(on) (MAX.)}$ | 30m $\Omega$ |
| $I_D$               | 50A          |

Pin Description:



Single N Channel MOSFET

UIS, Rg 100% Tested

Pb-Free Lead Plating & Halogen Free



ABSOLUTE MAXIMUM RATINGS ( $T_C = 25^\circ\text{C}$  Unless Otherwise Noted)

| PARAMETERS/TEST CONDITIONS                     |  | SYMBOL           | LIMITS     | UNIT             |
|--|--|------------------|------------|------------------|
| Gate-Source Voltage                            |  | $V_{GS}$         | $\pm 20$   | V                |
| Continuous Drain Current                       | $T_C = 25^\circ\text{C}$                             | $I_D$            | 50         | A                |
|  | $T_C = 100^\circ\text{C}$                            |                  | 35         |                  |
| Pulsed Drain Current <sup>1</sup>              |  | $I_{DM}$         | 150        |                  |
| Avalanche Current                              |  | $I_{AS}$         | 30         |                  |
| Avalanche Energy                               | $L = 0.1\text{mH}, I_D = 30\text{A}, R_G = 25\Omega$ | $E_{AS}$         | 45         | mJ               |
| Repetitive Avalanche Energy <sup>2</sup>       | $L = 0.05\text{mH}$                                  | $E_{AR}$         | 22.5       |                  |
| Power Dissipation                              | $T_C = 25^\circ\text{C}$                             | $P_D$            | 128        | W                |
|  | $T_C = 100^\circ\text{C}$                            |                  | 50         |                  |
| Operating Junction & Storage Temperature Range |  | $T_{j}, T_{stg}$ | -55 to 150 | $^\circ\text{C}$ |

THERMAL RESISTANCE RATINGS

| THERMAL RESISTANCE  | SYMBOL          | TYPICAL | MAXIMUM | UNIT                        |
|---------------------|-----------------|---------|---------|-----------------------------|
| Junction-to-Case    | $R_{\theta JC}$ |         | 0.97    | $^\circ\text{C} / \text{W}$ |
| Junction-to-Ambient | $R_{\theta JA}$ |         | 62.5    |                             |

<sup>1</sup>Pulse width limited by maximum junction temperature.

<sup>2</sup>Duty cycle  $\leq 1\%$

<sup>3</sup>Pulsed drain current rating is package limited.



ELECTRICAL CHARACTERISTICS ( $T_c = 25\text{ }^\circ\text{C}$ , Unless Otherwise Noted)

| PARAMETER   | SYMBOL        | TEST CONDITIONS   | LIMITS |      |           | UNIT       |
|---|---------------|---|--------|------|-----------|------------|
|   |               |   | MIN    | TYP  | MAX       |            |
| <b>STATIC</b>   |               |   |        |      |           |            |
| Drain-Source Breakdown Voltage  | $V_{(BR)DSS}$ | $V_{GS} = 0V, I_D = 250\mu A$                                 | 100    |      |           | V          |
| Gate Threshold Voltage  | $V_{GS(th)}$  | $V_{DS} = V_{GS}, I_D = 250\mu A$                             | 1.0    | 1.7  | 3.0       |            |
| Gate-Body Leakage   | $I_{GSS}$     | $V_{DS} = 0V, V_{GS} = \pm 20V$                               |        |      | $\pm 100$ | nA         |
| Zero Gate Voltage Drain Current   | $I_{DSS}$     | $V_{DS} = 80V, V_{GS} = 0V$                                   |        |      | 1         | $\mu A$    |
|   |               | $V_{DS} = 70V, V_{GS} = 0V, T_J = 125\text{ }^\circ\text{C}$  |        |      | 25        |            |
| On-State Drain Current <sup>1</sup>   | $I_{D(ON)}$   | $V_{DS} = 10V, V_{GS} = 10V$                                  | 50     |      |           | A          |
| Drain-Source On-State Resistance <sup>1</sup>   | $R_{DS(ON)}$  | $V_{GS} = 10V, I_D = 30A$                                     |        | 26   | 30        | m $\Omega$ |
|   |               | $V_{GS} = 4.5V, I_D = 20A$                                    |        | 28   | 35        |            |
| Forward Transconductance <sup>1</sup>   | $g_{fs}$      | $V_{DS} = 5V, I_D = 30A$                                      |        | 38   |           | S          |
| <b>DYNAMIC</b>  |               |   |        |      |           |            |
| Input Capacitance   | $C_{iss}$     | $V_{GS} = 0V, V_{DS} = 50V, f = 1MHz$                         |        | 2725 |           | pF         |
| Output Capacitance  | $C_{oss}$     |   |        | 209  |           |            |
| Reverse Transfer Capacitance  | $C_{rss}$     |   |        | 57   |           |            |
| Gate Resistance   | $R_g$         | $V_{GS} = 15mV, V_{DS} = 0V, f = 1MHz$                        |        | 1.5  |           | $\Omega$   |
| Total Gate Charge <sup>1,2</sup>  | $Q_g$         | $V_{DS} = 50V, V_{GS} = 10V,$<br>$I_D = 30A$                  |        | 38   |           | nC         |
| Gate-Source Charge <sup>1,2</sup>   | $Q_{gs}$      |   |        | 6.8  |           |            |
| Gate-Drain Charge <sup>1,2</sup>  | $Q_{gd}$      |   |        | 9.1  |           |            |
| Turn-On Delay Time <sup>1,2</sup>   | $t_{d(on)}$   | $V_{DS} = 50V,$<br>$I_D = 1A, V_{GS} = 10V, R_{GS} = 6\Omega$ |        | 25   |           | nS         |
| Rise Time <sup>1,2</sup>  | $t_r$         |   |        | 110  |           |            |
| Turn-Off Delay Time <sup>1,2</sup>  | $t_{d(off)}$  |   |        | 100  |           |            |
| Fall Time <sup>1,2</sup>  | $t_f$         |   |        | 120  |           |            |
| <b>SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (<math>T_c = 25\text{ }^\circ\text{C}</math>)</b> |               |   |        |      |           |            |
| Continuous Current  | $I_S$         |   |        |      | 50        | A          |
| Pulsed Current <sup>3</sup>   | $I_{SM}$      |   |        |      | 150       |            |
| Forward Voltage <sup>1</sup>  | $V_{SD}$      | $I_F = I_S, V_{GS} = 0V$                                      |        |      | 1.3       | V          |
| Reverse Recovery Time   | $t_{rr}$      | $I_F = 25A, di_F/dt = 100A / \mu S$                           |        | 120  |           | nS         |
| Reverse Recovery Charge   | $Q_{rr}$      |   |        | 380  |           | nC         |

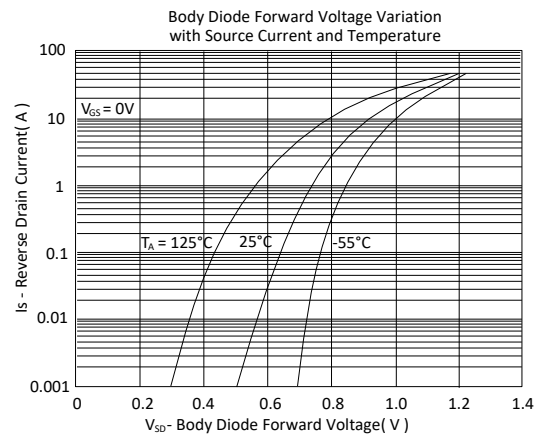
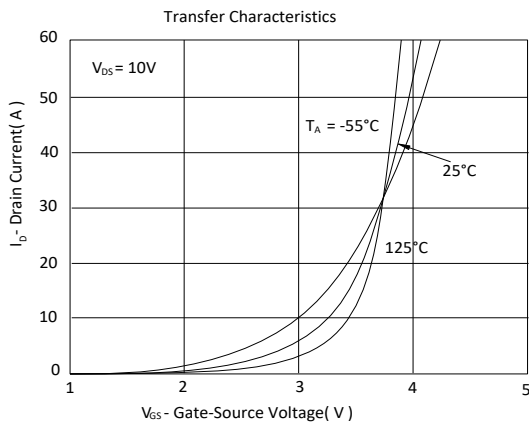
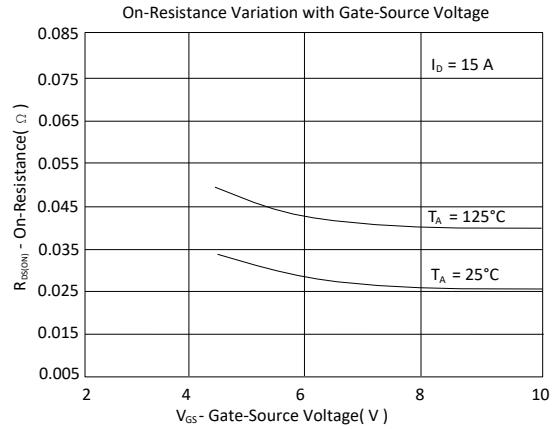
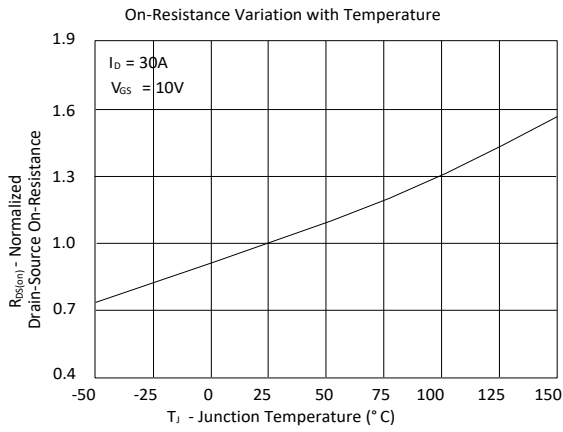
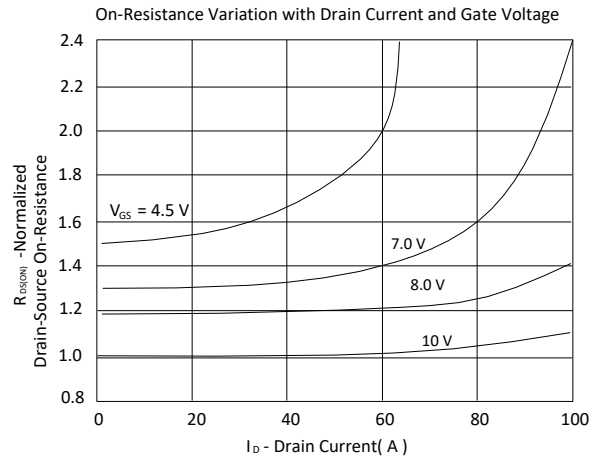
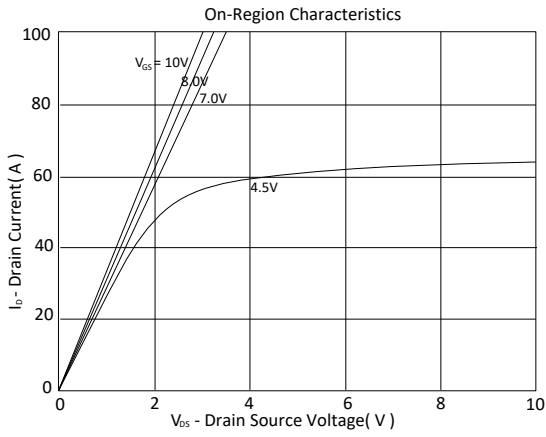
<sup>1</sup>Pulse test : Pulse Width  $\leq 300\ \mu\text{sec}$ , Duty Cycle  $\leq 2\%$ .

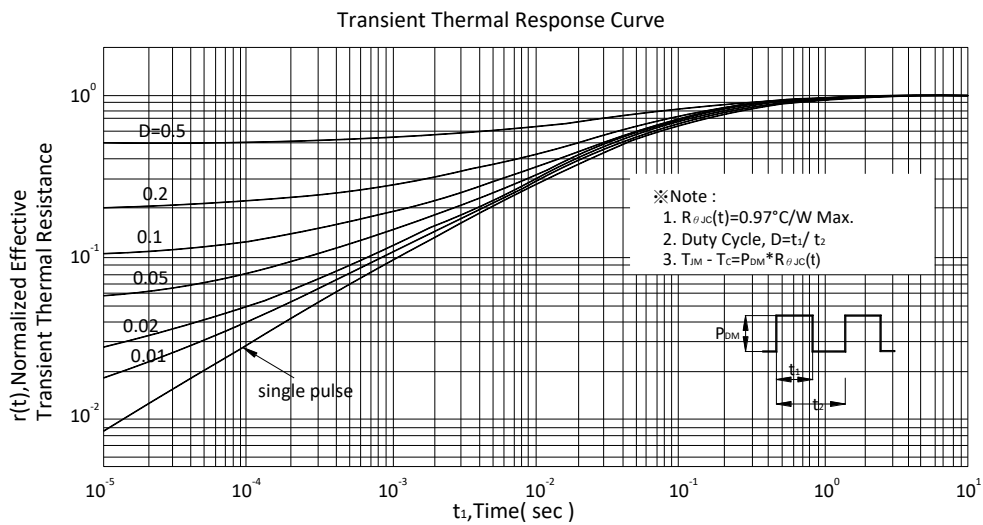
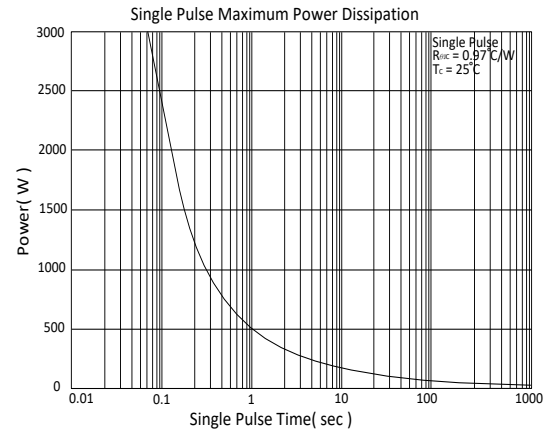
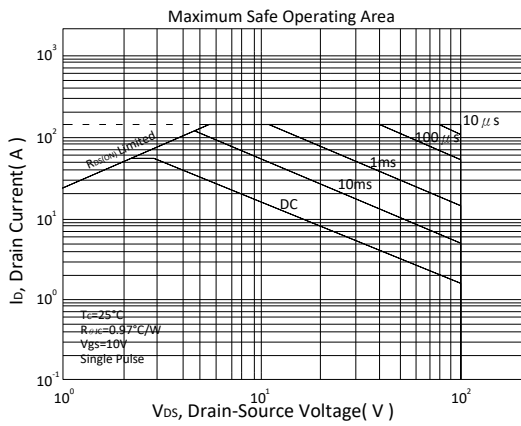
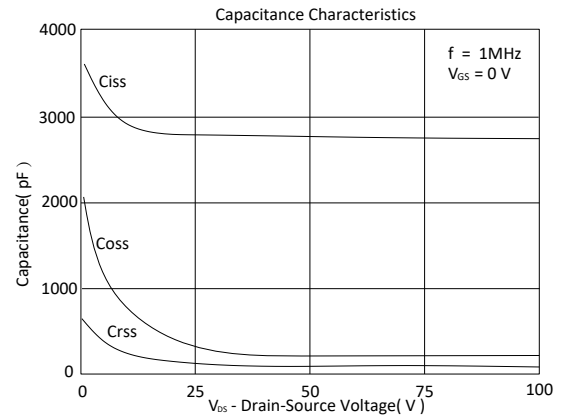
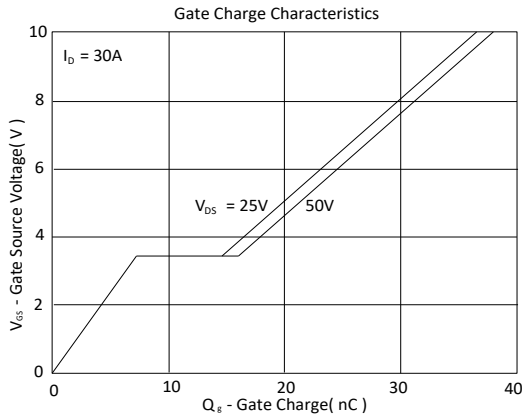
<sup>2</sup>Independent of operating temperature.

<sup>3</sup>Pulse width limited by maximum junction temperature.



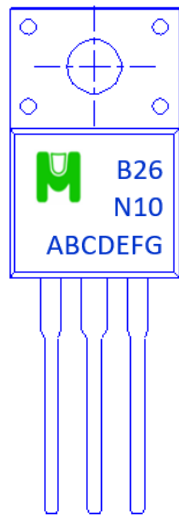
TYPICAL CHARACTERISTICS





Ordering & Marking Information:

Device Name: EMB26N10F for TO-220F



→ B26N10: Device Name

→ ABCDEFG: Date Code

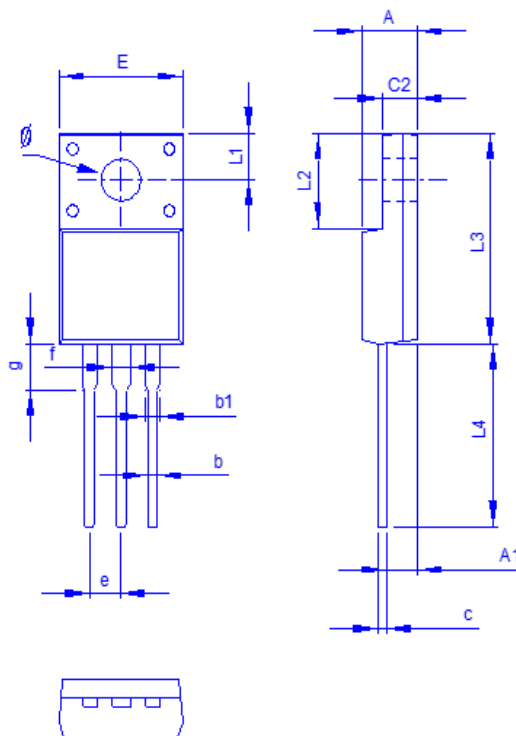
A: Assembly House

B: Year(A:2008 B:2009 C:2010....)

C: Month(A:01 B:02 C:03 D:04 E:05 F:06 G:07 H:08 I:09 J:10 K:11 L:12)

DEFG: Serial No.

Outline Drawing



Dimension in mm

|      | A   | A1   | b    | b1  | c    | c2   | E     | L1   | L2   | L3    | L4    | ∅    | e    | f    | g    |
|------|-----|------|------|-----|------|------|-------|------|------|-------|-------|------|------|------|------|
| Min. | 4.3 | 2.49 | 0.5  | 1.1 | 0.4  | 2.34 | 9.96  | 2.7  | 6.48 | 14.8  | 12.65 | 3    | 2.44 | 1.17 | 2.93 |
| Typ. | 4.5 | 2.59 | 0.8  | 1.3 | 0.5  | 2.54 | 10.1  | 3.25 | 6.68 | 15.87 | 12.98 | 3.1  | 2.54 | 1.28 | 3.03 |
| Max. | 4.9 | 2.96 | 0.95 | 1.6 | 0.75 | 3.2  | 10.36 | 3.45 | 6.9  | 16.2  | 13.5  | 3.38 | 2.64 | 1.75 | 4    |



◆ Tube Information: 50pcs/Tube (1000pcs/Box)

